APPLICA		IDARD										
OPERATING TEMPERATUR		RE RANGE	-55 °C TO 85 °C (1)		TEM		PERATURE RANGE		-10 °C TO 60 °C			
RATING	VOLTAGE		30 V AC		OPE RAN		HUMIDITY	95 % RH MAX.				
CURRENT								DEW CONDENSATION IS	PERMITT	ED)		
SPECIFICATIONS												
IT	EM		TEST METHOD				REQUIREMENTS				АТ	
CONSTRU	JCTION											
GENERAL EXAMINATION			VISUALLY AND BY MEASURING INSTRUMENT.				ACCORDING TO DRAWING.				×	
MARKING		CONFIRMED VISUALLY.								×	×	
ELECTRIC CHARAC						T						
CONTACT RESISTANCE		100 mA (DC OR 1000 Hz).			100 mΩ MAX .				×			
INSULATION RESISTANCE		100 V DC				50 MΩ MIN.				×		
VOLTAGE PROOF		100 V AC FOR 1 min.			NO FLASHOVER OR BREAKDOWN.				×			
MECHANI	CAL CHAP	RACTER	ISTICS							l		
INSERTION AND		MEASURED BY APPLICABLE CONNECTOR.				PIN	INSER		WITHDRAWAL	×		
WITHDRAWAL FORCE								E (MAX)	FORCE (MIN)	4		
\wedge						24 40		9.6N 6 N	4.96 N 5.6 N	\parallel		
<u> </u>						60		64 N	6.4 N	+		
MECHANICAL OPERATION		30 TIME	30 TIMES INSERTIONS AND EXTRACTIONS.			 ① CONTACT RESISTANCE: 120 mΩ MAX. ② NO DAMAGE, CRACK AND LOOSENESS 				×		
VIBRATION		FREOLI	FREQUENCY 10 TO 55 Hz,				OF PARTS. ① NO ELECTRICAL DISCONTINUITY OF					
VIBRATION		SINGLE AMPLITUDE: 0.75 mm, 10 CYCLES IN 3 AXIAL DIRECTIONS.			1 μs MIN. ② NO DAMAGE, CRACK AND LOOSENESS OF PARTS.				×			
SHOCK		490 m/s ² , DURATION OF PULSE 11 ms FOR 3 TIMES IN 3 BOTH AXIAL DIRECTIONS.							×			
ENVIRON	MENTAL (CHARAC	TERISTICS									
DAMP HEAT		EXPOSE	EXPOSED AT 40±2 °C, 90 ~ 95 %, 96 hrs.			① COI	① CONTACT RESISTANCE: 120 m Ω MAX.					
(STEADY STATE)						(2) INSULATION RESISTANCE: 25 M Ω MIN. (3) NO DAMAGE, CRACK AND LOOSENESS OF PARTS.						
RAPID CHANGE OF		TEMPERATURE -55→+15~+35→+85→+15~+35°C				① CONTACT RESISTANCE: 120 m Ω MAX.				×		
TEMPERATURE A		TIME $30 \rightarrow 2 \sim 3 \rightarrow 30 \rightarrow 2 \sim 3$ min. 5 CYCLES.			② INSULATION RESISTANCE: 50 MΩ MIN.③ NO DAMAGE, CRACK AND LOOSENESS OF PARTS.							
CORROSION SALT MIST			EXPOSED IN 5 % SALT WATER SPRAY FOR 48 hrs.				NO HEAVY CORROSION.					
SULPHUR DIOXIDE		EXPOSED IN 25 PPM FOR 96 hrs. (TEST STANDARD: JIS C 0090)				×						
RESISTANCE TO		1) REFLO	1) REFLOW SOLDERING : 250 °C MAX,			NO DEFORMATION OF CASE OF				×		
SOLDERING HEAT			: 220 °C MIN,			EXCESSIVE LOOSENESS OF THE						
		2) SOLD	FOR 60 sec. 2) SOLDERING IRONS : 360 °C,			TERMINALS.				×		
			FOR 5 sec.									
SOLDERABILITY			SOLDERED AT SOLDER TEMPERATURE, 240°C FOR IMMERSION DURATION, 3 sec.			A NEW UNIFORM COATING OF SOLDER SHALL COVER A MINIMUM OF 95% OF THE SURFACE BEING IMMERSED.				×		
COUN	Т	DESCRIPTI	ON OF REVISIONS		DESI	SNED		(CHECKED		TE	
2		DIS-F-006120			TS. (TS. 00N0		HT	T. YAMAGUCH I	12. 03. 26		
			RE RISE INCLUDED WHEN ENERGIZED.				APPROV	ED	HS. OKAWA	06.0	4. 11	
(2			E INDICATES A LONG-TERM STORAGE STATE USED PRODUCT BEFORE THE BOARD MOUNTED.				CHECK	ED	HT. YAMAGUCHI	06.0	4. 11	
	,					DESI		ED	TH. NODA	06.0	4. 10	
Unless ot	herwise sp	ecified, r	ecified, refer to JIS C 5402.			DRAW		N _	TH. NODA	06.0	06. 04. 10	
Note QT:Qualification Test AT:Assurance Test X:Applicable Test					D	RAWING NO.			ELC4-156244-00			
HS.			PECIFICATION SHEET			PART NO.		FX1	2B-*P-0. 4SV			
	HIF	HIROSE ELECTRIC CO., LTD.			CODI	NO.				<u> </u>	1/1	